



2814

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:  
Todd O. Bolken

Serial No.: 09/516,080

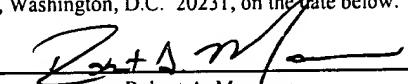
Filed: March 1, 2000

For: EXPOSED DIE MOLDING  
APPARATUS

§ Group Art Unit: 2814  
§  
§ Examiner: Louie, Wai Sing  
§  
§ Atty Docket: MICS:0043 FLE/MAN  
§ 99-0634

#3 Response  
marsha  
2/14/03

Assistant Commissioner  
for Patents  
Washington, D.C. 20231

CERTIFICATE OF MAILING 37 C.F.R. 1.8	
I hereby certify that this correspondence is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231, on the date below:	
February 5, 2003 _____ Date	 Robert A. Manware

Sir:

RESPONSE

In response to the Official Action mailed on November 5, 2002, Applicant respectfully  
requests reconsideration of the above-identified application in view of the remarks set forth  
below.

RECEIVED  
FEB 13 2003  
TECHNOLOGY CENTER 2800